

### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Akira Ishikawa Art Unit : 2811
Serial No. : 10/728,903 Examiner : Unknown

Filed: December 8, 2003 Confirmation No.: 9311

Title : SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

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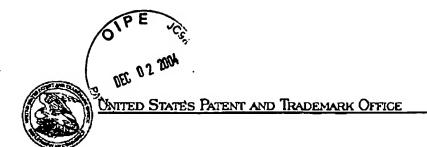
Date: 12/2/04

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CONFIRMATION NO. 9311

**UPDATED FILING RECEIPT** \*OC000000014210560\*

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Applicant(s)

Akira Ishikawa, Kanagawa, JAPAN;

Assignment For Published Patent Application

Semiconductor Energy Laboratory Co. Ltd., a Japan corporation

**Power of Attorney:** John Hayden-37640

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W. Karl Renner - 41, 265 Domestic Priority data as claimed by applicant

Diana Di Berardino - 45,653

This application is a DIV of 09/951,384 09/14/2001 PAT 6,682,963

Foreign Applications

JAPAN 2000-280864 09/14/2000 JAPAN 2000-280902 09/14/2000

If Required, Foreign Filing License Granted: 09/13/2004

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is US10/728,903

Projected Publication Date: 02/03/2005

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Non-Publication Request: No

Early Publication Request: No

Title

Semiconductor device and manufacturing method thereof

**Preliminary Class** 

257

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As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

on the invention entitle SEMIC		VICE AND MANUFACTU	RING METHOD THER	EOF
the specificat	ion of which:			
l is attach	ned hereto.			
was file	d on	_ as Application Serial No	and was amended	
[ ] was des	cribed and claimed i	in PCT International Application and as amended under PC	No.	filed
on		and as amended under re	1 Atticle 19 off	
I hereby state	that I have reviewed	d and understand the contents of t	he ahove-identified specifica	tion,
ncluding the claims,	is amended by any a	mendment referred to above.		
I ecknowledo	e the duty to disclos	e all information I know to be ma	terial to patentability in acco	rdance with
Title 37, Code of Fede	ral Regulations, §1.	56.		1.,,
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I hereby clair below and, insofar as States application in the duty to disclose all Regulations, \$1.56(a) international filing da  U.S. So  I hereby clair for patent or inventor than the United States inventor's certificate of States of America file priority is claimed:	n the benefit under I the subject matter of the manner provided i I information I know which became availa te of this application erial No.  In foreign priority be a certificate or of ar to of America listed b or any PCT internati d by me on the same	Fitle 35, United States Code, §120 feach of the claims of this application by the first paragraph of Title 35, who be material to patentability as able between the filing date of the normal state.  Filing Date  refits under Title 35, United States by PCT international application (see low and have also identified belianal application(s) designating at subject matter having a filing date.	of any United States application is not disclosed in the punited States Code, \$112, I a defined in Title 37, Code of prior application and the natistance Status  Status  S Code, \$119 of any foreign a s) designating at least one comments on the comment of the supplication of the supplic	rior United cknowledge Federal onal or PCT pplication(s) untry other or patent or, the United n(s) of which
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## Combined Declaration and Power of Attorney Page 2 of 2 Pages

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I hereby declare that all statements made herein of my own knowledge are true and that it statements made on information and belief are believed to be true; and further that these statements were made with the fnowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, wider Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validay of the application or any patents issued thereon.

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